National Semiconductor is now part of

Texas Instruments.

Search <u>http://www.ti.com/</u> for the latest technical

information and details on our current products and services.



DS90C032QML LVDS Quad CMOS Differential Line Receiver

General Description

The DS90C032 is a quad CMOS differential line receiver designed for applications requiring ultra low power dissipation and high data rates.

The DS90C032 accepts low voltage differential input signals and translates them to CMOS (TTL compatible) output levels. The receiver supports a TRI-STATE® function that may be used to multiplex outputs.

The DS90C032 and companion line driver (DS90C031) provide a new alternative to high power psuedo-ECL devices for high speed point-to-point interface applications.

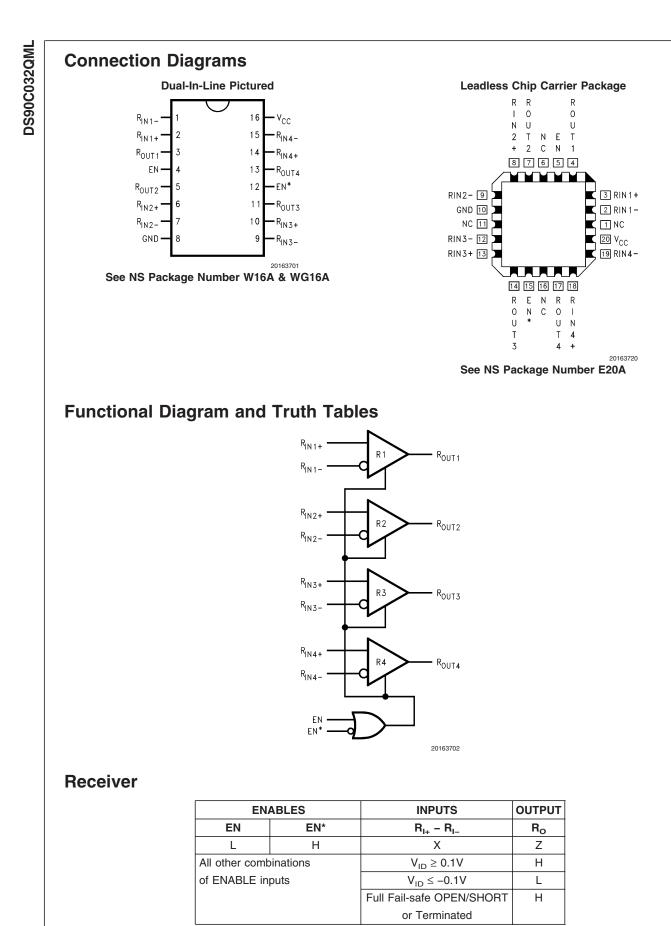
In addition, the DS90C032A provides power-off high impedance LVDS inputs. This feature assures minimal loading effect on the LVDS bus lines when $V_{\rm CC}$ is not present.

Features

- High impedance LVDS inputs with power-off.
- Accepts small swing (330 mV) differential signal levels
- Low power dissipation.
- Low differential skew.
- Low chip to chip skew.
- Pin compatible with DS26C32A
- Compatible with IEEE 1596.3 SCI LVDS standard

Ordering information						
NS Part Number	SMD Part Number	NS Package Number	Package Description			
DS90C032E-QML	5962-9583401Q2A	E20A	20LD Leadless Chip Carrier			
DS90C032W-QML	5962-9583401QFA	W16A	16LD Ceramic Flatpack			
DS90C032WG-QML	5962-9583401QZA	WG16A	16LD Ceramic SOIC			
DS90C032W-QMLV	5962-9583401VFA	W16A	16LD Ceramic Flatpack			
DS90C032WG-QMLV	5962-9583401VZA	WG16A	16LD Ceramic SOIC			
DS90C032WLQMLV	5962L9583401VFA	W16A	16LD Ceramic Flatpack			
	50K rd(Si)					
DS90C032WGLQMLV	5962L9583401VZA	WG16A	16LD Ceramic SOIC			
	50K rd(Si)					

Ordering Information



DS90C032QML

Absolute Maximum Ratings (Note 1)

Supply Voltage (V _{CC})	-0.3V to +6V
Input Voltage (R _I +, R _I -)	-0.3V to (V _{CC} +0.3V)
Enable Input Voltage	-0.3V to (V _{CC} +0.3V)
(EN, EN*)	
Output Voltage (R _O)	-0.3V to (V _{CC} +0.3V)
Storage Temperature Range (T _{Stg})	$-65^{\circ}C \le T_A \le +150^{\circ}C$
Lead Temperature Range	+260°C
Soldering (4 sec.)	
Maximum Package Power Dissipation @ +25°C (Note 2)	
LCC Package	1,830 mW
Ceramic Flatpack	1,400 mW
Ceramic SOIC	1,400 mW
Thermal Resistance	
θ_{JA}	
LCC Package	82°C/W
Ceramic Flatpack	145°C/W
Ceramic SOIC	145°C/W
θ _{JC}	
LCC Package	20°C/W
Ceramic Flatpack	20°C/W
Ceramic SOIC	20°C/W
ESD Rating (Note 3)	2KV

Recommended Operating Conditions

	Min	Тур	Max
Supply Voltage (V _{CC})	+4.5V	+5.0V	+5.5V
Receiver Input Voltage	Gnd		2.4V
Operating Free Air Temperature (T _A)	–55°C	+25°C	+125°C

Radiation Features

DS90C032WLQMLV	50 krads (Si)
DS90C032WGLQMLV	50 krads (Si)

Quality Conformance Inspection

Mil-Std-883, Method 5005 - Group A

Subgroup	Description	Temp °C
1	Static tests at	25
2	Static tests at	125
3	Static tests at	-55
4	Dynamic tests at	25
5	Dynamic tests at	125
6	Dynamic tests at	-55
7	Functional tests at	25
8A	Functional tests at	125
8B	Functional tests at	-55
9	Switching tests at	25
10	Switching tests at	125
11	Switching tests at	-55
12	Settling time at	25
13	Settling time at	125
14	Settling time at	-55

DC Parameters (Note 7)

							Sub-
Symbol	Parameter	Conditions	Notes	Min	Max	Units	groups
V _{ThL}	Differential Input Low Threshold	$V_{CM} = +1.2V$	(Note 4)		-100	mV	1, 2, 3
V _{ThH}	Differential Input High Threshold	V _{CM} = +1.2V	(Note 4)		100	mV	1, 2, 3
l _{In}	Input Current	$V_{\rm CC}$ =5.5V, $V_{\rm I}$ = 2.4V			±10	μA	1, 2, 3
	(Input Pins)	$V_{\rm CC} = 5.5 V, V_{\rm I} = 0$			±10	μA	1, 2, 3
		$V_{\rm CC} = 0.0V, V_{\rm I} = 2.4V$			±10	μA	1, 2, 3
		$V_{\rm CC} = 0.0 V, V_{\rm I} = 0.0 V$			±10	μA	1, 2, 3
V _{OH}	Output High Voltage	V_{CC} = 4.5V, I_{OH} = -0.4 mA, V_{ID} = 200mV		3.8		V	1, 2, 3
V _{OL}	Output Low Voltage	$V_{CC} = 4.5, I_{OL} = 2 \text{ mA},$ $V_{ID} = -200\text{mV}$			0.3	V	1, 2, 3
I _{os}	Output Short Circuit Current	Enabled, V _O = 0V		-15	-100	mA	1, 2, 3
I _{oz}	Output TRI-STATE Current	Disabled, $V_O = 0V$ or V_{CC}			±10	μA	1, 2, 3
V _{IH}	Input High Voltage		(Note 4)	2.0		V	1, 2, 3
V _{IL}	Input Low Voltage		(Note 4)		0.8	V	1, 2, 3
I _I	Input Current (Enable Pins)	$V_{CC} = 5.5V$			±10	μA	1, 2, 3
V _{CL}	Input Clamp Voltage	I _{CI} = -18mA			-1.5	V	1, 2, 3
I _{cc}	No Load Supply Current	EN, EN* = V _{CC} or Gnd, Inputs Open			11	mA	1, 2, 3
		EN, EN* = 2.4 or 0.5, Inputs Open			11	mA	1, 2, 3
I _{ccz}	No Load Supply Current Receivers Disabled	EN = Gnd, EN* = V _{CC} , Inputs Open			11	mA	1, 2, 3

www.national.com

AC Parameters (Note 7)

The following conditions apply, unless otherwise specified.

AC: $V_{CC} = 4.5V / 5.0V / 5.5V, C_L = 20pF$

Symbol	Parameter	Conditions	Notes	Min	Мах	Units	Sub- groups
t _{PHLD}	Differential Propagation Delay	V _{ID} = 200mV,		1.0	8.0	ns	9, 10, 11
	High to Low	Input pulse = $1.1V$ to $1.3V$,					
		$V_1 = 1.2V$ (0V differential) to V_0					
		= 1/2 V _{CC}					
t _{PLHD}	Differential Propagation Delay	$V_{ID} = 200 mV,$		1.0	8.0	ns	9, 10, 11
	Low to High	Input pulse = $1.1V$ to $1.3V$,					
		$V_{I} = 1.2V$ (0V differential) to V_{O}					
		= 1/2 V _{CC}					
t _{SkD}	Differential Skew t _{PHLD} - t _{PLHD}	$C_L = 20pF, V_{ID} = 200mV$			3.0	ns	9, 10, 11
t _{Sk1}	Channel to Channel Skew	$C_{L} = 20 pF, V_{ID} = 200 mV$	(Note 5)		3.0	ns	9, 10, 11
t _{Sk2}	Chip to Chip Skew	$C_L = 20pF, V_{ID} = 200mV$	(Note 6)		7.0	ns	9, 10, 11
t _{PLZ}	Disable Time Low to Z	Input pulse = 0V to 3.0V,			20	ns	9, 10, 11
		$V_{O} = V_{OL} + 0.5V,$					
		$R_L = 1K\Omega$ to V_{CC} , $V_I = 1.5V$					
t _{PHZ}	Disable Time High to Z	Input pulse = 0V to 3.0V,			20	ns	9, 10, 11
		$V_{I} = 1.5V, V_{O} = V_{OH} - 0.5V,$					
		$R_L = 1K\Omega$ to Gnd					
t _{PZH}	Enable Time Z to High	Input pulse = 0V to 3.0V,			20	ns	9, 10, 11
		$V_{I} = 1.5V, V_{O} = 50\%,$					
		$R_L = 1K\Omega$ to Gnd					
t _{PZL}	Enable Time Z to Low	Input pulse = 0V to 3.0V,			20	ns	9, 10, 11
		$V_{I} = 1.5V, V_{O} = 50\%,$					
		$R_L = 1K\Omega$ to V_{CC}					

AC/DC Post Radiation Limits (Note 7)

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub- groups
I _{cc}	No Load Supply Current	EN, EN* = V _{CC} or Gnd, Inputs Open			20	mA	1
		EN, EN* = 2.4 or 0.5, Inputs Open			20	mA	1
I _{CCZ}	No Load Supply Current Receivers Disabled	EN = Gnd, EN* = V _{CC} , Inputs Open			20	mA	1

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 2: Derate LCC @ 12.2mW/°C above +25°C. Derate ceramic flatpack @ 6.8mW/°C above +25°C

Note 3: Human body model, 1.5 k Ω in series with 100 pF.

Note 4: Tested during V_{OH} / V_{OL} tests.

Note 5: Channel-to-Channel Skew is defined as the difference between the propagation delay of one channel and that of the others on the same chip with an event on the inputs.

Note 6: Chip to Chip Skew is defined as the difference between the minimum and maximum specified differential propagation delays.

Note 7: Pre and post irradiation limits are identical to those listed under AC & DC electrical characteristics except as listed in the "Post Radiation Limits" table. Radiation end point limits for the noted parameters are guaranteed only for the conditions, as specified.

Parameter Measurement Information

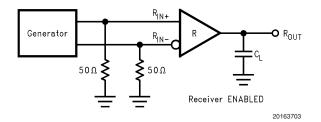


FIGURE 1. Receiver Propagation Delay and Transition Time Test Circuit

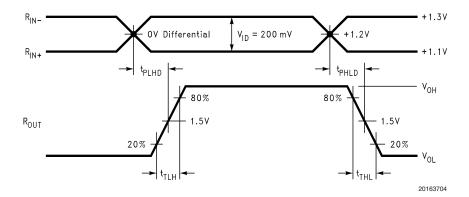
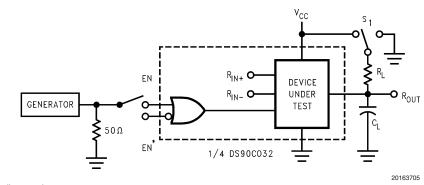


FIGURE 2. Receiver Propagation Delay and Transition Time Waveforms

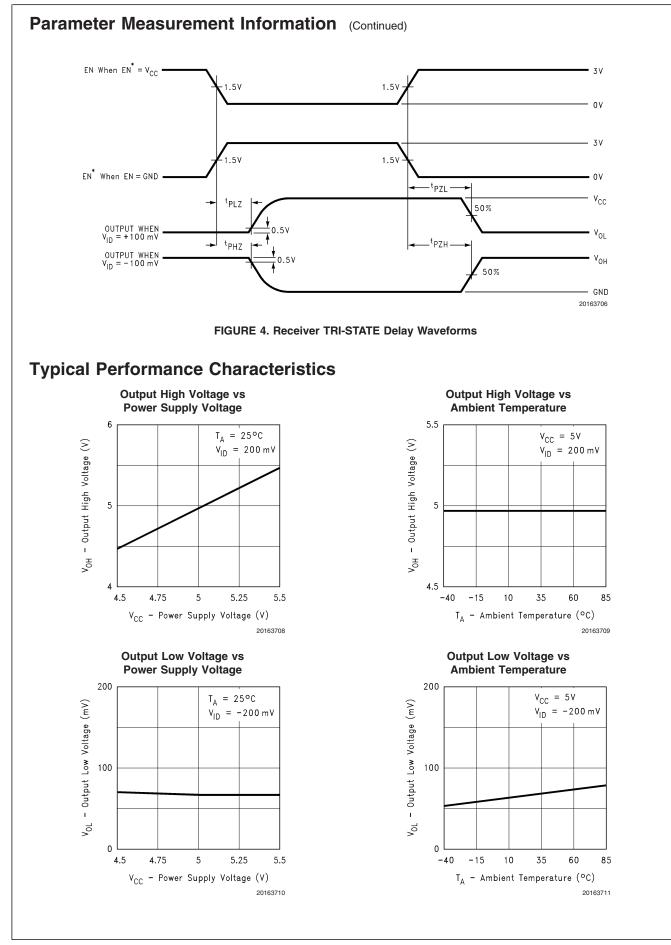


 C_{L} includes load and test jig capacitance.

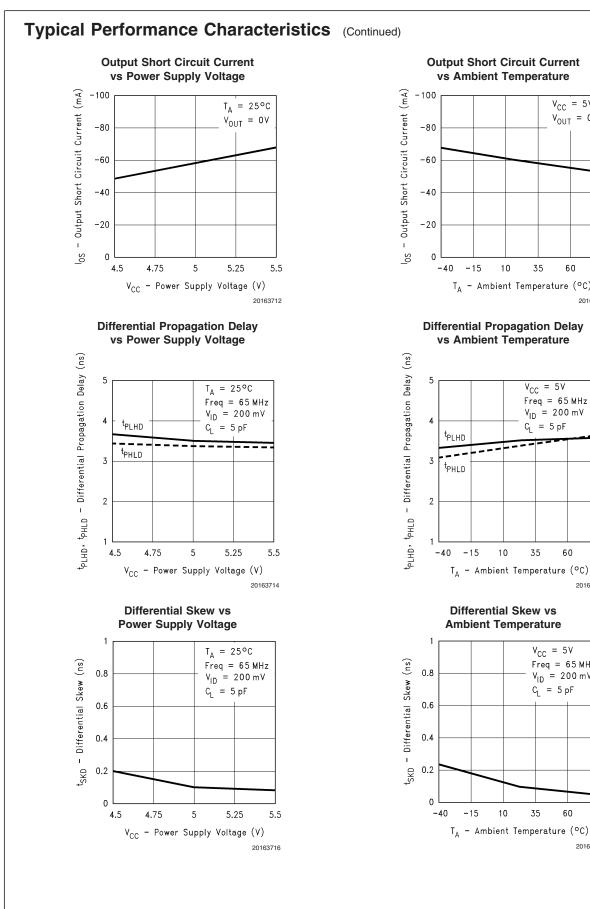
 $S_1 = V_{CC}$ for t_{PZL} and t_{PLZ} measurements.

 S_1 = Gnd for t_{PZH} and t_{PHZ} measurements.





DS90C032QML





 $V_{CC} = 5V$ $V_{OUT} = 0V$

-15

-15

-15

10

10

35

- Ambient Temperature (°C)

10

35

 $\overline{V_{CC}} = 5V$

 $C_L = 5 pF$

Freq = 65 MHz

 $V_{ID} = 200 \text{ mV}$

- Ambient Temperature (°C)

60

85

20163713

85

85

20163717

60

20163715

60

 $V_{CC} = 5V$

CL ______ = 5 pF

35

Freq = 65 MHz

 $V_{ID} = 200 \text{ mV}$

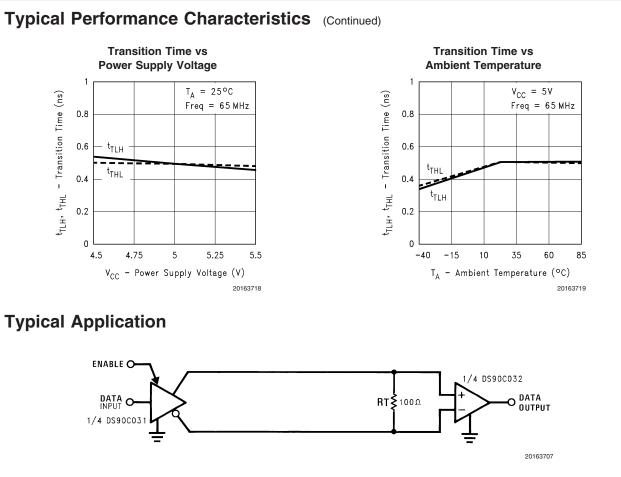


FIGURE 5. Point-to-Point Application

Applications Information

LVDS drivers and receivers are intended to be primarily used in an uncomplicated point-to-point configuration as is shown in Figure 5. This configuration provides a clean signaling environment for the quick edge rates of the drivers. The receiver is connected to the driver through a balanced media which may be a standard twisted pair cable, a parallel pair cable, or simply PCB traces. Typically the characteristic impedance of the media is in the range of 100Ω . A termination resistor of 100Ω should be selected to match the media, and is located as close to the receiver input pins as possible. The termination resistor converts the current sourced by the driver into a voltage that is detected by the receiver. Other configurations are possible such as a multi-receiver configuration, but the effects of a mid-stream connector(s), cable stub(s), and other impedance discontinuities as well as ground shifting, noise margin limits, and total termination loading must be taken into account.

The DS90C032 differential line receiver is capable of detecting signals as low as 100 mV, over a \pm 1V common-mode range centered around +1.2V. This is related to the driver offset voltage which is typically +1.2V. The driven signal is centered around this voltage and may shift \pm 1V around this center point. The \pm 1V shifting may be the result of a ground potential difference between the driver's ground reference and the receiver's ground reference, the common-mode effects of coupled noise, or a combination of the two. Both receiver input pins should honor their specified operating input voltage range of 0V to +2.4V (measured from each pin to ground), exceeding these limits may turn on the ESD protection circuitry which will clamp the bus voltages.

RECEIVER FAIL-SAFE

The LVDS receiver is a high gain, high speed device that amplifies a small differential signal (20mV) to CMOS logic levels. Due to the high gain and tight threshold of the receiver, care should be taken to prevent noise from appearing as a valid signal.

The receiver's internal fail-safe circuitry is designed to source/sink a small amount of current, providing fail-safe protection (a stable known state of HIGH output voltage) for floating, terminated or shorted receiver inputs.

1. **Open Input Pins.** The DS90C032 is a quad receiver device, and if an application requires only 1, 2 or 3 receivers, the unused channel(s) inputs should be left OPEN. Do not tie unused receiver inputs to ground or any other voltages. The input is biased by internal high value pull up and pull down resistors to set the output to a HIGH state. This internal circuitry will guarantee a HIGH, stable output state for open inputs.

DS90C032QML

Applications Information (Continued)

2. **Terminated Input.** The DS90C032 requires external failsafe biasing for terminated input failsafe.

Terminated input failsafe is the case of a receiver that has a 100Ω termination across its inputs and the driver is in the following situations. Unplugged from the bus, or the driver output is in TRI-STATE or in power-off condition. The use of external biasing resistors provide a small bias to set the differential input voltage while the line is un-driven, and therefore the receiver output will be in HIGH state. If the driver is removed from the bus but the cable is still present and floating, the unplugged cable can become a floating antenna that can pick up noise. The LVDS receiver is designed to detect very small amplitude and width signals and recover them to standard logic levels. Thus, if the cable picks up more than 10mV of differential noise, the receiver may respond. To insure that any noise is seen as commonmode and not differential, a balanced interconnect and twisted pair cables is recommended, as they help to ensure that noise is coupled common to both lines and rejected by the receivers.

3. Shorted Inputs. If a fault condition occurs that shorts the receiver inputs together, thus resulting in a 0V differential input voltage, the receiver output will remain in a HIGH state. Shorted input fail-safe is not supported across the common-mode range of the device (1.2V $\pm 1V$). It is only supported with inputs shorted and no external common-mode voltage applied.

4. Operation in environment with greater than 10mV differential noise.

National recommends external failsafe biasing on its LVDS receivers for a number of system level and signal quality reasons. First, only an application that requires failsafe biasing needs to employ it. Second, the amount of failsafe biasing is now an application design parameter and can be custom tailored for the specific application. In applications in low noise environments, they may choose to use a very small bias if any. For applications with less balanced interconnects and/or in high noise environments they may choose to boost failsafe further. Nationals "LVDS Owner's Manual provides detailed calculations for selecting the proper failsafe biasing resistors. Third, the common-mode voltage is biased by the resistors during the un-driven state. This is selected to be close to the nominal driver offset voltage (V_{OS}). Thus when switching between driven and un-driven states, the common-mode modulation on the bus is held to a minimum.

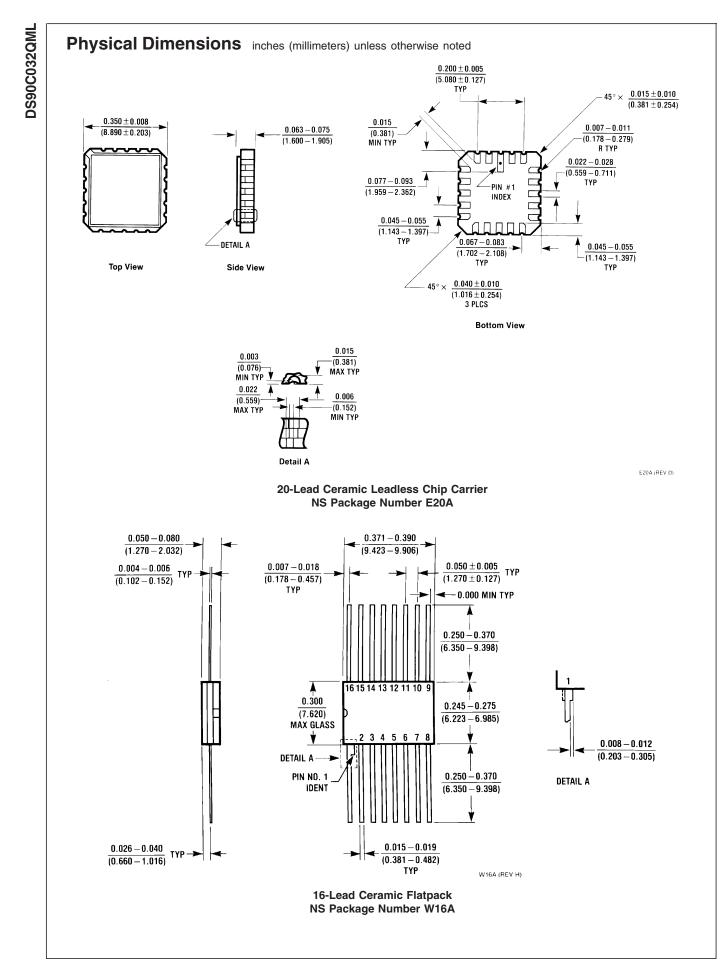
For additional Failsafe Biasing information, please refer to Application Note AN-1194 for more detail.

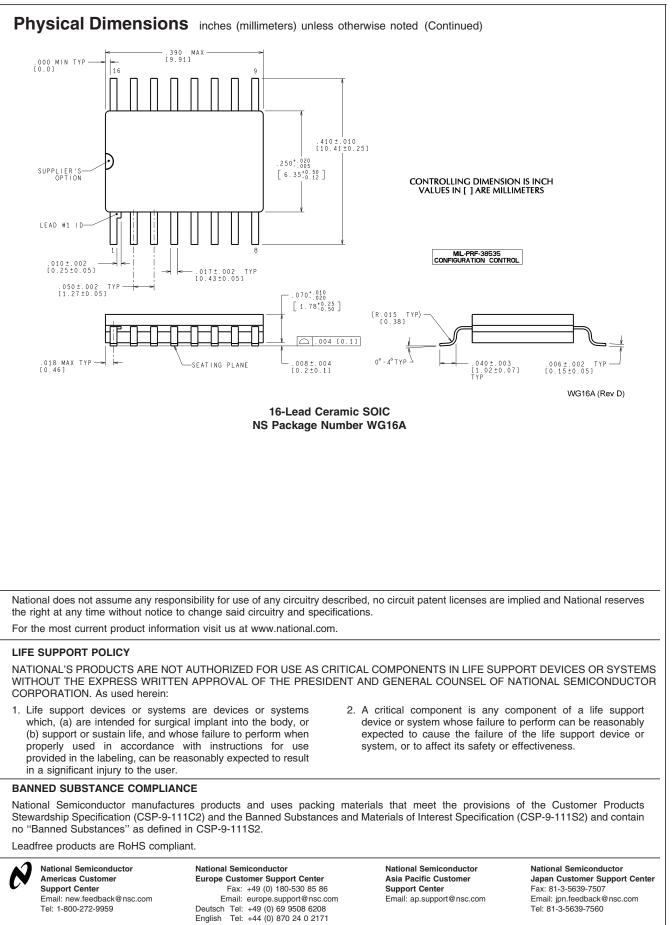
The footprint of the DS90C032 is the same as the industry standard 26LS32 Quad Differential (RS-422) Receiver.

Pin No. (SOIC)	Name	Description	
2, 6, 10, 14	R _{I+}	Non-inverting receiver input pin	
1, 7, 9, 15	R _{I-}	Inverting receiver input pin	
3, 5, 11, 13	Ro	Receiver output pin	
4	EN	Active high enable pin, OR-ed with EN*	
12	EN*	Active low enable pin, OR-ed with EN	
16	V _{CC}	Power supply pin, +5V ± 10%	
8	Gnd	Ground pin	

Pin Descriptions

eleased	Revision	Section	Originator	Changes
3/01/06	A	New Release, Corporate format	L. Lytle	1 MDS data sheet converted into Corp. data sheet format. MNDS90C032-X-RH Rev 1B1 will be archived.





Français Tel: +33 (0) 1 41 91 8790

DS90C032QML LVDS Quad CMOS Differential Line Receiver

www.national.com